



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re the Application of: **Koji NOZAKI et al.**

Group Art Unit: **1752**

Serial-Number: **10/623,679**

Examiner: **Amanda C. Walke**

Filed: **July 22, 2003**

Confirmation Number: **5083**

For: **RESIST PATTERN THICKENING MATERIAL, RESIST PATTERN
AND PROCESS FOR FORMING THE SAME, AND
SEMICONDUCTOR DEVICE AND PROCESS FOR
MANUFACTURING THE SAME**

Attorney Docket Number: **030891**
Customer Number: **38834**

AMENDMENT UNDER 37 CFR §1.111

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

February 28, 2006

Sir:

This paper is filed in response to the Office Action dated November 29, 2005.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 10 of this paper.